IN THE SPECIFICATION

On page 1, line 1, please insert--

AI

, • •

THE THE PROPERTY OF THE PROPER

Cross Reference to Related Applications

This application is a continuation application of United States Patent
Application entitled "Method And Arrangement For Layout And Manufacture Of
Gridless Non Manhattan Semiconductor Integrated Circuits," filed on 6/3/01, and having
the Serial No. 09/681,775.--

IN THE TITLE:

Please replace the original title of the patent application with the revised title --Method and Arrangement For Layout and Manufacture of NonManhattan Semiconductor Integrated Circuit Using Simulated Euclidean Wiring--